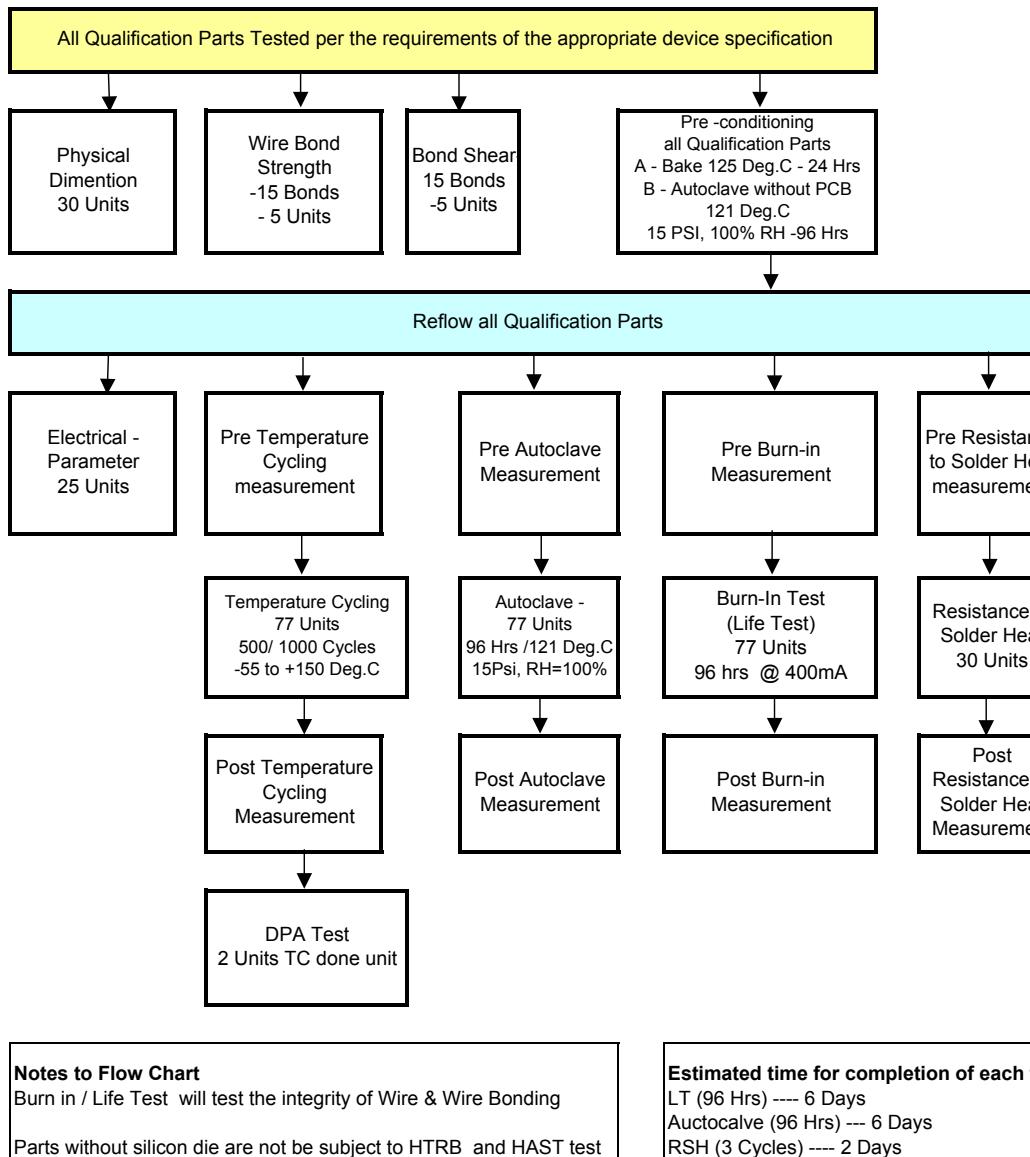




Rev 2011-03-01A

Qual Flow Chart for AEC - Q101 Jumper SOT23 with special wire bonding



Notes to Flow Chart

Burn in / Life Test will test the integrity of Wire & Wire Bonding

Parts without silicon die are not be subject to HTRB and HAST test
HTRB = High temperature Reverse Bias
HAST = High Acceleration Temperature/Humidity Stress Test

Estimated time for completion of each test :

LT (96 Hrs) --- 6 Days
Autoclave (96 Hrs) --- 6 Days
RSH (3 Cycles) --- 2 Days
Temperature Cycling (1000 cycles) --102 days